



TOS-F5167AA-B

SMD Display LED

Part Number	(Chip	Face	Segment Color	
	Material	Source Color	Color		
TOS-F5167AA-B	GaAsP	Amber	Black	White	

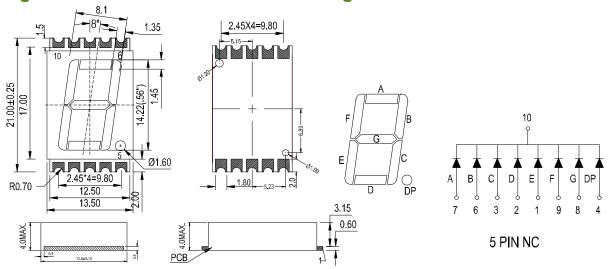
Features

- (0.56") 14.22mm digit height
- · Common cothode
- · I.C. compatible
- Low power consumption
- · RoHS compliant

Applications

- Audio equipment
- · Instrument panels
- · Digital read out display

Package Dimensions & Internal Circuit Diagram



Notes:

- 1. All dimensions are in millimeters, tolerance: ±0.25; Angle: ±0.1° unless otherwise noted.
- 2. Specifications are subject to change without notice.

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Absolute Maximum Rating @ Ta=25°C

Parameter	Maximum Rating	Unit	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	mA	
Power Dissipation	75	mW	
Continuous Forward Current	20	mA	
Recommend Operating Current	12	mA	
Reverse Voltage	5	V	
Operating Temperature Range	-25°C to +85°C		
Storage Temperature Range	-30°C to +85°C		
Lead-Free Solder Temperature	250°C for 10 Sec		

Electrical / Optical Characteristic @ Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	Grade
Luminous Intensity	lv		3000		ucd	I _F =10mA	
Dominant Wavelength	$\lambda_{\sf d}$		605		nm	I _F =20mA	
Spectral Line Half-Width	Δλ		35		nm	I _F =20mA	
Forward Voltage	V_{F}	1.8	2.1	2.4	V	I _F =20mA	
Reverse Current	I _R			100	μA	V _R =5V	
Luminous Intensity Matching Rate	lv-m			2.0:1		I _F =20mA	

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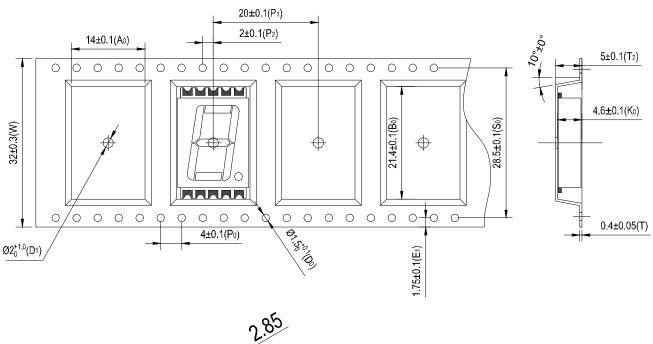
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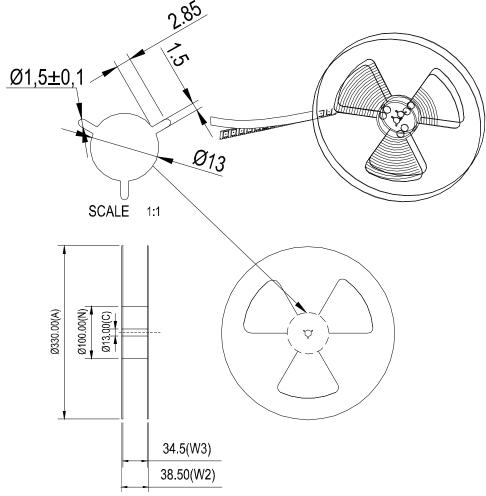
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Package Description





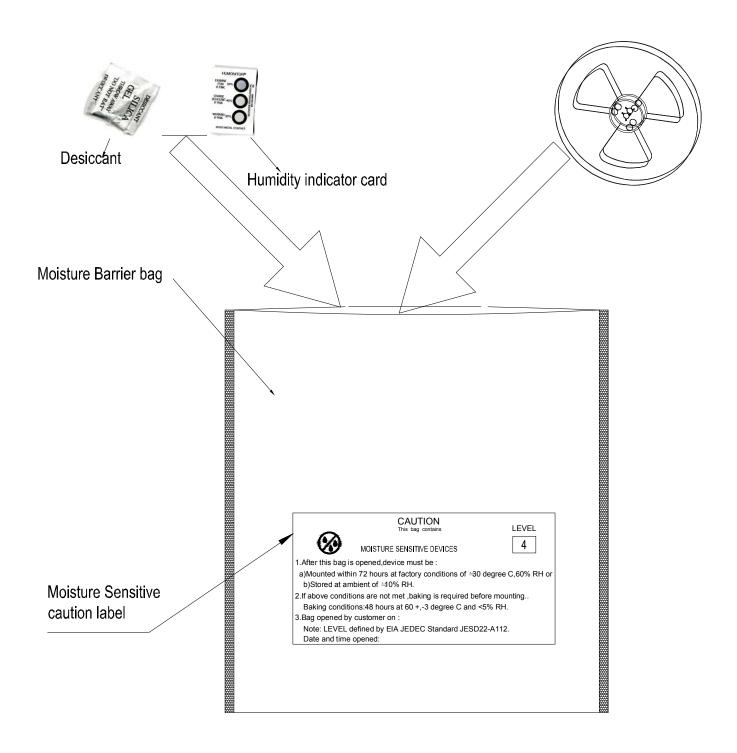
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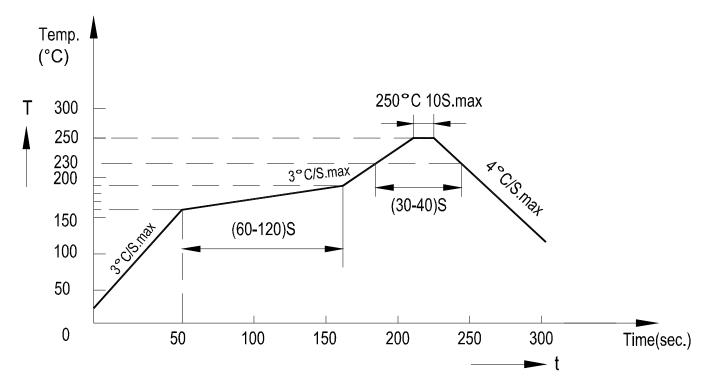






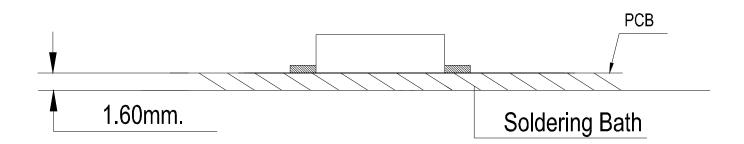


Soldering Profile



Number of reflow process shall be 2 times or less

- 1. Manual soldering temperature: Max 320°C for 3 Sec
- 2. Can be second manual soldering, but must be cooling before second manual soldering, In order to guarantee the soldered area is to be smoothly covered with soldering, can delay the soldering time, but not to exceed 20s every pad, because if that, the pad will be damaged.
- 3. The minimum distance of display seating plan to soldering bath is 1.6mm.
- 4. Don't cause stress to the epoxy resin while it is exposed to high temperature.



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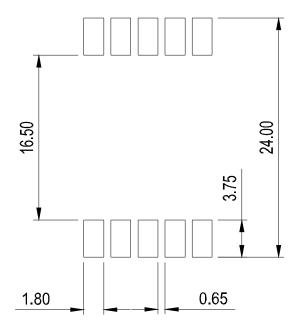
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Recommended Soldering Pattern and Storage Condition



- 1. This part is a moisture sensitive device, According to JEDEC level 4.
- 2. The storage condition of packed: $\!\!\!<\!40^\circ$ / 90%RH, 12 months or $\!\!\!<\!\!\!$ 10%RH
- 3. The storage condition of unpacked: \leq 30° / 60%RH, 72 Hrs or \leq 10%RH

This part can endure ultrasonic cleaning, the solvent hydrocarbon is suitable but isopropyl-alcohol base is not.